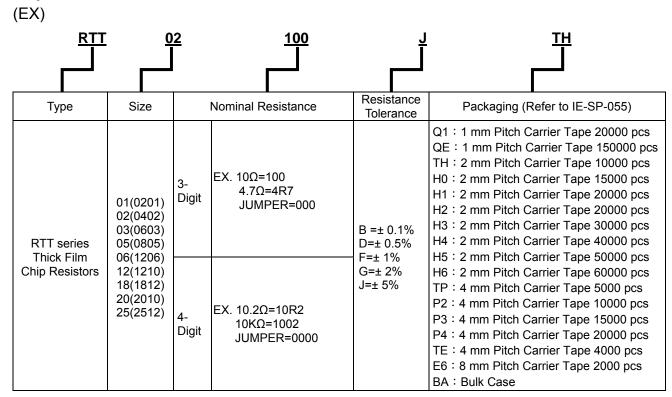
### RTT Series Thick Film Chip Resistors Product Specification

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#### 1 Scope:

- 1.1 This specification is applicable to lead free and halogen free of RoHS directive for RTT series thick film chip resistors
- 1.2 The product is for general purpose.

### 2 Explanation Of Part Numbers:



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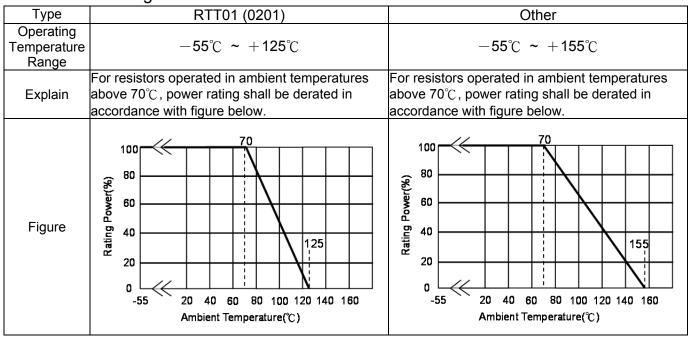
### RTT Series Thick Film Chip Resistors Product Specification

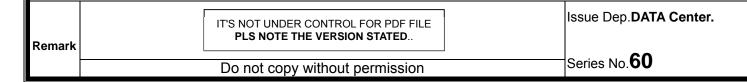
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3 General Specifications:

Rated Max. Max. Type Power at Working Overload			T.C.R (ppm/°C)	114111					JUMPER Rated Current		JUMPER Resistance Value	
	70℃ Voltage Voltage		(ppill/C)	B(±0.1%) E-24 \ E-96	D(±0.5%) E-24 \ E-96	F(±1%) E-24 \ E-96	G(±2%) \ J(±5%) E-24	J (±5%)	F (±1%)	J (±5%)	F (±1%)	
RTT01	<u>1</u> W	25V	50V	-200 +400		$1\Omega \le R < 10\Omega$	$1\Omega \le R < 10\Omega$	1Ω≦R<10Ω	0.5A	0.5A	50mΩ	35mΩ MAX.
(0201)	20			±200	$47\Omega\!\leqq\!R\!\leqq\!1M\Omega$	$10\Omega\!\leq\!R\!\leq\!10M\Omega$	$10\Omega\!\leq\!R\!\leq\!10M\Omega$	$10\Omega\!\leq\!R\!\leq\!10M\Omega$			MAX.	IVIAA.
RTT02	W	50V	100V	±100	$100\Omega \! \leq \! R \! \leq \! 1M\Omega$	$10\Omega {\le} R {\le} 1M\Omega$	$10\Omega {\le} R {\le} 22M\Omega$	$10\Omega \! \leq \! R \! \leq \! 22M\Omega$	1A	1.5A	50mΩ	20mΩ
(0402)	16	50 V	1000	±200			$1\Omega \le R < 10\Omega$	1Ω≦R<10Ω	IA	1.5A	MAX.	MAX.
RTT03	1	75V	150V	±100	$100\Omega \! \leq \! R \! \leq \! 1M\Omega$	10Ω≦R≦1MΩ	$10\Omega {\le} R {\le} 22M\Omega$	$10\Omega {\le} R {\le} 22M\Omega$	1A	2A	50mΩ MAX.	20mΩ MAX.
(0603)	1 10 W	750	1500	±200		$1\Omega \le R < 10\Omega$	$1\Omega \le R < 10\Omega$	1Ω≦R<10Ω				
RTT05	1 8	150V	300V	±100	$100\Omega {\le} R {\le} 1M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	10Ω≦R≦27MΩ	10Ω≦R≦27MΩ	2A	2.5A	50mΩ MAX.	20mΩ MAX.
(0805)	8 VV	1500	3000	±200		1Ω≦R<10Ω	1Ω≦R<10Ω	1Ω≦R<10Ω				
RTT06	W	200V	400V	±100	10Ω≦R≦1MΩ	$10\Omega {\le} R {\le} 10M\Omega$	10Ω≦R≦27MΩ	10Ω≦R≦27MΩ	2A	3.5A	50mΩ MAX.	20mΩ MAX.
(1206)	4	200V	4000	±200	3Ω≦R<10Ω	1Ω≦R<10Ω	1Ω≦R<10Ω	1Ω≦R<10Ω	ZA.			
RTT12	1 2 W	200V	400V	±100	$100\Omega {\le} R {\le} 1M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	10Ω≦R≦27MΩ	10Ω≦R≦27MΩ	2A	4A	50mΩ	20mΩ MAX.
(1210)	2 70	200V	4000	±200			1Ω≦R<10Ω	1Ω≦R<10Ω	ZA.	4A	MAX.	
RTT18	3_W	200V	400V	±100	$100\Omega {\le} R {\le} 1M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	10Ω≦R≦20MΩ	10Ω≦R≦20MΩ	2A	5A	50mΩ	20mΩ
(1812)	4	200V	4000	±200			1Ω≦R<10Ω	1Ω≦R<10Ω	ZA.	ЭA	MAX.	MAX.
RTT20	3 4	2001/	400)/	±100	$100\Omega {\le} R {\le} 1M\Omega$	$10\Omega{\le}R{\le}10M\Omega$	$10\Omega{\le}R{\le}20M\Omega$	10Ω≦R≦20MΩ		<b>5</b> A	50mΩ	20mΩ MAX.
(2010)	(2010) 4 W	200V	400V	±200			1Ω≦R<10Ω	1Ω≦R<10Ω	2A	5A	MAX.	
RTT25	4107	2001/	400)/	±100	$100\Omega {\le} R {\le} 1M\Omega$	$10\Omega{\le}R{\le}10M\Omega$	$10\Omega{\le}R{\le}20M\Omega$	10Ω≦R≦20MΩ	0.4	7.0	50mΩ MAX.	20mΩ MAX.
(2512)	1W 2	200V	400V	±200			1Ω≦R<10Ω	1Ω≦R<10Ω	2A	7A		
Oper	ating Tem	perature	Range			-55°C ~ +	155℃ (0201:-	-55℃ ~ +125°	C)			

### 3.1 Power Derating Curve:





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#### 3.2 Voltage Rating:

Rated Voltage: The resistor shall have a DC continuous working voltage or a rms. AC continuous working voltage at commercial-line frequency and wave form corresponding to the power rating, as determined from the following

$$E = \sqrt{R \times P}$$

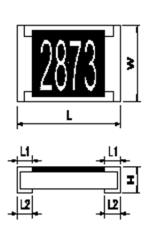
E= Rated voltage (v)

P= Power rating (w)

R= Nominal resistance( $\Omega$ )

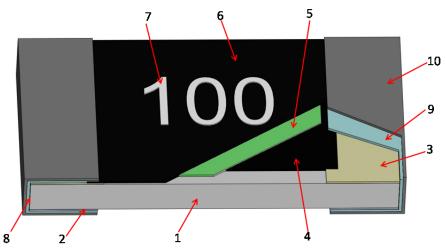
#### 4 Dimensions:

Unit:mm



	Dimension					
		L	W	Н	L1	L2
Туре	Size Code					
RTT01	0201	0.60±0.03	0.30±0.03	0.23±0.03	0.10±0.05	0.15±0.05
RTT02	0402	1.00±0.10	0.50±0.05	0.30±0.05	0.20±0.10	0.25±0.10
RTT03	0603	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.15	0.30±0.15
RTT05	0805	2.00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.15
RTT06	1206	3.05±0.10	1.55±0.10	0.50±0.10	0.45±0.20	0.35±0.15
RTT18	1812	4.40±0.20	3.15±0.20	0.47±0.20	0.60±0.20	0.60±0.20
RTT12	1210	3.05±0.10	2.55±0.10	0.55±0.10	0.50±0.20	0.50±0.20
RTT20	2010	5.00±0.20	2.50±0.20	0.55±0.10	0.60±0.20	0.60±0.20
RTT25	2512	6.30±0.20	3.20±0.20	0.55±0.10	0.60±0.20	0.60±0.20

### 5 Structure Graph:



1	Ceramic substrate	6	2nd Protective coating
2	Bottom inner electrode	7 Marking	
3	Top inner electrode	8	Terminal inner electrode
4	Resistive layer	9	Ni plating
5	1st Protective coating	10	Sn plating

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### 6 Reliability Test:

### 6.1 Electrical Performance Test

Item	Conditions	Specifications	
no	Contaillone	Resistors	Jumper
Temperature Coefficient of	TCR (ppm / °C) = $\frac{(R2-R1)}{R1 (T2-T1)}$ ×10 <sup>6</sup> R1: Resistance at room temperature R2: Resistance at -55°C or +125°C T1: Room temperature T2: Temperature -55°C or +125°C	Refer to item 3. general specifications	NA
Short Time Overload	Refer to JIS-C5201-1 4.8  Applied 2.5 times rated voltage for 5 seconds and release the load for about 30 minutes, then measure its resistance variance rate. (Rated voltage refer to item 3. general specifications)  Refer to JIS-C5201-1 4.13	0.1% × 0.5% × 1%:△R%=±1.0% 2% × 5%:△R%=±2.0%	Refer to item 3. general specifications
	Put the resistor in the fixture, add 100 VDC in + ,- terminal for 60 sec then measured the insulation resistance between electrodes and insulating enclosure or between electrodes and base material. Refer to JIS-C5201-1 4.6	≥ 10 <sup>9</sup> Ω	
Dielectric Withstand Voltage	Put the resistor in the fixture, add VAC (see SPEC below) in +,-terminal for.  RTT05 \ 06 \ 12 \ 18 \ 20 \ 25 apply 500 VAC 1 minute.  RTT01 \ 02 \ 03 apply 300 VAC 1 minute.  Refer to JIS-C5201-1 4.7	No short or burned on the appea	rance.
Intermittent Overload	Put the tested resistor in chamber under temperature $25\pm2^{\circ}\mathbb{C}$ and load 2.5 times rated DC voltage for 1 sec on, 25 sec off, $ \begin{array}{ccccccccccccccccccccccccccccccccccc$	∆R%=±5.0%	Refer to item 3. general specifications

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### 6.2 Mechanical Performance Test

Item	Conditions	Specifications	
		Resistors	Jumper
Terminal Strength	Test 1: The resistor mounted on the board applied 5N pushing force on the sample rear for 10 sec. (RTT01:3N) Test 2: The resistor mounted on the board slowly add force on the sample rear until the sample termination is breakdown.  Refer to JIS-C5201-1 4.16	Test 1 : No evidence of mechanical d Test 2 : RTT01≧3N Other Type≧5N	amage.
Resistance to Solvent	The tested resistor be immersed into isopropyl alcohol of 20~25°C for 5 minutes, then the resistor is left in the room for 48 hrs, and measured its resistance variance rate.  Refer to JIS-C5201-1 4.29	Type RTT01 Other ΔR% ΔR%=± .0% ΔR%=±0.5%	Refer to item 3. general specifications
Solderability	Put the tested resistor in the apparatus of PCT, at a temperature of 105°C, humidity of 100% RH, and pressure of 1.22×105 Pa for a duration of 4 hours. Then after left the tested resistor in room temperature for 2 hours or more.	Solder coverage over 95%	
Resistance to Soldering Heat	for 10 seconds. Then the resistor is left in the room for 1 hour.  Test method 2 (Solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for 30 seconds. Then the resistor is left as placed under microscope to observe its solder area.  Test method 3 (Electric iron test): Preheating temperature: 350±10°C	Test item 1:  (1).Variance rate on resistance  ΔR%=±1.0%  Test item 2:  (1).Solder coverage over 95%.  (2).The underlying material  (such as ceramic) shall not be visible at the crest corner area of the electrode.  Test item 3:  (1).Variance rate on resistance  ΔR%=±1.0%	Refer to item 3. general specifications

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Item	Conditions	Specifications	
item	Conditions	Resistors	Jumper
	Solder tested resistor on to PC board add force in the middle down, and under load measured its resistance variance rate.	∆R%=±1.0%	Refer to item 3. general specifications
	D:RTT02 \ 03 \ 05=5mm RTT01 \ 06 \ 12=3mm RTT18 \ 20 \ 25=2mm		
Joint Strength of Solder	Salder Supporting jig  Chip resistor		
	Pressurtze  OHM Meter		
	Refer to JIS-C5201-1 4.33		

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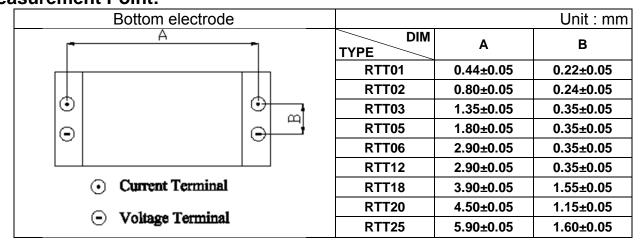
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#### 6.3 Environmental Test

Item	Conditions		Specifications	
item			Resistors	Jumper
Resistance to Dry Heat	Put tested resistor in chamber under temperature 155±5°C for 1000 +48/-0 hours. Then leaving the tested resistor in room temperature for 60 minutes, and measure its resistance variance rate.(RTT01 for 125±3°C)		0.1% \ 0.5% \ 1%:∆R%=±1.0% 2% \ 5%:∆R%=±2.0%	Refer to item 3. general specifications
	Put the tested resistor in the chamber which shown in the following table sha consecutively. Then leaving the tested temperature for 1 hours, and measure rate.	0.1% \ 0.5% \ 1%:△R%=±0.5% 2% \ 5%:△R%=±1.0%	Refer to item 3. general specifications	
Shock	resting Condition			
Criodic	Lowest Temperature	-55±5°C		
	Highest Temperature Temperature-retaining time	125±5℃ 15 minutes each		
	Refer to MIL-STD 202 Method 107	10 minutes each		
Loading Life in Moisture	Put the tested resistor in the chamber under temperature 40±2°C, relative humidity 90~95% and load the rated voltage for 90 minutes on, 30 minutes off, total 1000 hours. Then leaving the tested resistor in room temperature for 60 minutes, and measure its resistance variance rate.  Refer to JIS-C5201-1 4.24		Type RTT01 Other  1%: 0.1% \ \cdot 0.5% \ \cdot 1%  \[ \lambda R\lambda = +1.0\lambda \] \[ \lambda R\lambda = +0.5\lambda \]	Refer to item 3. general specifications
Load Life	Put the tested resistor in chamber under temperature 70±2°C and load the rated voltage for 90 minutes on, 30 minutes off, total 1000 hours. Then leaving the tested resistor in room temperature for 60 minutes, and measure its resistance variance rate.  Refer to JIS-C5201-1 4.25		Type RTT01 Other  1%:	Refer to item 3. general specifications

#### 7 Measurement Point:

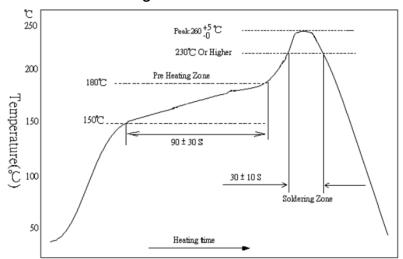


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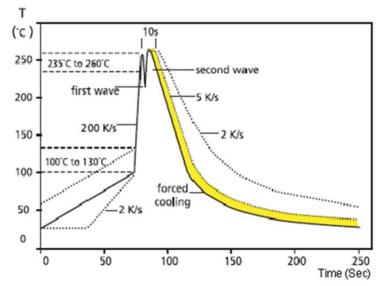
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- 8 Plating Thickness:
  - **8.1 Ni**: $\ge$ **2**  $\mu$  m
  - 8.2 Sn(Tin): $\ge$ 3  $\mu$  m
  - 8.3 Sn(Tin):Matte Sn
- 9 Technical application notes: (This is for recommendation, please customer perform adjustment according to actual application)
  - 9.1 Recommend Soldering Method:
    - 9.1.1 Lead Free IR Reflow Soldering Profile



9.1.2 Lead Free Double-Wave Soldering Profile.(This applies to 0603 size inclusive above products)



9.1.3 Soldering Iron: temperature 350°C±10°C, dwell time shall be less than 3 sec

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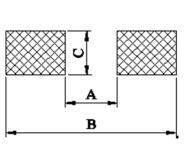
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Unit:mm

#### 9.2 Recommend Land Pattern Design (For Reflow Soldering)

When a component is soldered, the resistance after soldering changes slightly depending on the size of the soldering area and the amount of soldering. When designing a circuit, it is necessary to consider the effect of a decrease or increase in its resistance.



TYPE DIM	Α	В	O
RTT01	0.3	1.0	0.4
RTT02	0.5	1.5	0.6
RTT03	8.0	2.1	0.9
RTT05	1.2	3.0	1.3
RTT06	2.2	4.2	1.6
RTT12	2.2	4.2	2.8
RTT18	3.1	5.9	3.0
RTT20	3.5	6.1	2.8
RTT25	3.8	8.0	3.5

#### 9.3 Environment Precautions:

This specification product is for general electronic use, RALEC will not be responsible for any damage, cost or loss caused by using this specification product in any special environment. If other applications need to confirm with RALEC.

If consumer intends to use our Company product in special environment or condition (including but not limited to those mentioned below), then will need to make individual recognition of product features and reliability accordingly.

- (a) Used in high temperature and humidity environment;
- (b) Exposed to sea breeze or other corrosive gas, such as Cl2 \ H2S \ NH3 \ SO2 and NO2;
- (c) Used in non-verified liquids including water, oil, chemical and organic solvents;
- (d) Using non-verified resin or other coating material to seal or coat our Company product;
- (e) After soldering, it is necessary to use water-soluble detergents to clean residual solder
- (f) fluxes, even though no-clean fluxes are recommended.

#### 9.4 Momentary Overload Precautions:

The product might be out of function when momentary overloaded. Please make sure to avoid momentary overloading while using and preserving.

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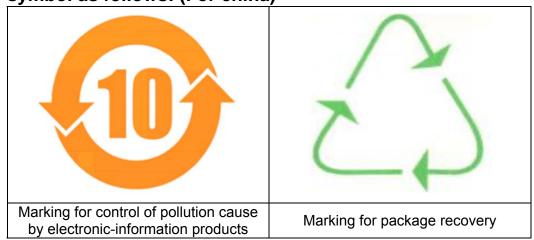
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- 9.5 Operation and Processing Precautions:
  - (a) Avoid damage to the edge of resistor and protective layer caused by mechanical stress.
  - (b) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
  - (c) Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resister will be overloaded. There might be machinery damage due to the climbing temperature.
  - (d) If the resister will be exposed under massive impact load (shock wave) in a short period of time, the working environment must be set up well before use.
  - (e) Please make evaluation and confirmation when the product is well used in your company and have a through consideration of it's fail-safe design to ensure the system safety.

#### 10 Stock period:

- 10.1 The temperature condition must be controlled at 25±5°C, the R.H. must be controlled at 60±15%. The stock can maintain quality level in two years.
- 10.2 Please avoid the mentioned harsh environment below when storing to ensure product performance and its' weldability. Places exposed to sea breeze or other corrosive gas, such as Cl<sub>2</sub> \ H<sub>2</sub>S \ NH<sub>3</sub> \ SO<sub>2</sub> and NO<sub>2</sub>.
- 10.3 When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.

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#### 12 Attachments:

12.1 Document Revise Record (QA-QR-027)

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